

Single-Layer Microchip Capacitors/ Thin Film Circuit Substrates



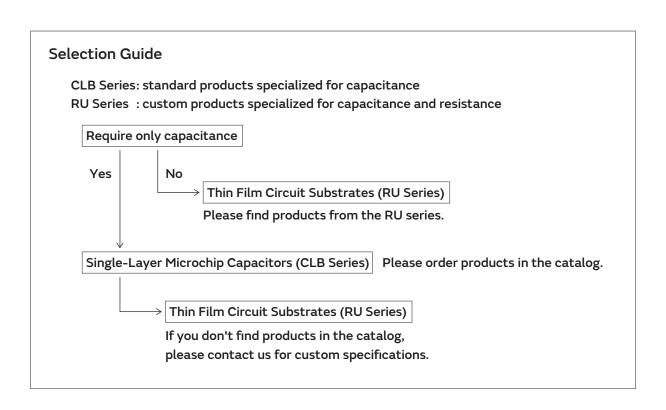
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Product specifications are as of April 2019.

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Please check the MURATA website (https://www.murata.com/) if you cannot find a part number in this catalog.



Part Numbering

Single-Layer Microchip Capacitors (CLB Series)

①Product ID

Product ID	
CL	Microchip Capacitors

2 Series

Code	Series
В	Gaps on Both Sides

Size

Code	Dimensions (L x W)
OA	0.25 x 0.25mm
ОВ	0.30 x 0.25mm
ос	0.35 x 0.25mm
0D	0.38 x 0.38mm
OE	0.55 x 0.38mm
ОН	0.71 x 0.38mm
05	0.50 x 0.50mm
0G	0.70 x 0.50mm
ок	0.90 x 0.50mm
OF	0.64 x 0.64mm
1A	1.00 x 0.64mm
OJ	0.76 x 0.76mm
1B	1.09 x 0.76mm
09	0.90 x 0.90mm
1E	1.49 x 0.90mm
1C	1.27 x 1.27mm
1G	1.73 x 1.27mm
2C	2.19 x 1.27mm
1H	1.78 x 1.78mm
2L	2.95 x 1.78mm
2E	2.29 x 2.29mm
3G	3.71 x 2.29mm

4Temperature Characteristics

Code	Temperature Range	Capacitance Change
5C	-25 to 85°C	0±30ppm/°C
6U	-25 to 85°C	-750±60ppm/°C
B5	-25 to 85°C	±10%
F9	-25 to 85°C	+30, -80%
W1	-25 to 85°C	+30, -90%

^{*}Reference Temp.: 25°C

6 Capacitance

Expressed by three figures. The unit is pico-farad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two numbers. If there is a decimal point, it is expressed by the capital letter "R." In this case, all figures are significant digits.

6Capacitance Tolerance

Code	Capacitance Tolerance
В	±0.1pF
K	±10%
М	±20%
z	+80%, -20%

Number of Electrodes

Code	Number of Electrodes
1	1
3	3
4	4
5	5

8 Individual Specification Code

Code	Individual Specification Code
000	Standard

Packaging

Code	Packaging
TC1	Tray
ZB	Expand Ring

Thin Film Circuit Substrates (RUSUB)

(Part Number) RU C H D 1R5K 01001 GT TC

1 2 3 4 5 6 7 3

1 Product ID

Pruduct ID	
RU	Thin Film Circuit Substrates

2Representative Characteristics

Code	Representative Characteristics
С	Capacitance
R	Resistance
D	Dimensions

3Substrate Materials

Code	arepsilonr
N	9
Α	10
Н	39
K	90
U	150
F	250
Υ	3000
Z	10000
Х	15000
Q	30000

Substrate material code: A=Alumina, N=Aluminum Nitride arepsilonr: Dielectric Constant (Reference)

4 Metallization Materials

Indicated by 1 alphabetical character.

6Characteristic Values

Representative characteristics are indicated by 4 digit alphanumeric characters.

6Individual Specification Code

Indicated by 5 alphanumeric characters.

7Other Specifications

Indicated by 2 alphabetical characters.

8 Packaging

Code	Packaging
TC	Tray
ZB	Expand Ring

Single-Layer Microchip Capacitors

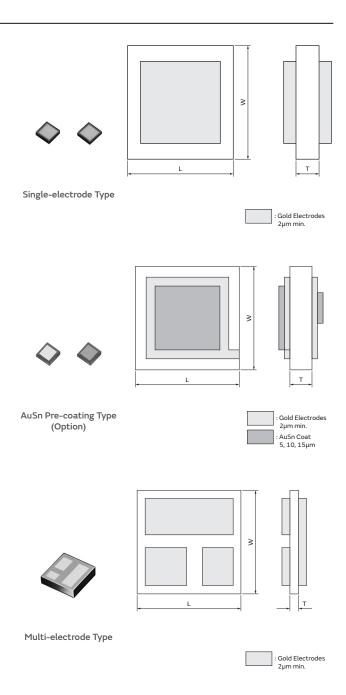
CLB Series

Features

- Simple single-layer structure combined with fine-grained high-density ceramic, and pure gold electrode provides very reliable performance and excellent frequency characteristics.
- 2. A wide selection of sizes from very miniature 0.25mm square is suited to high-density mounting.
- 3. By utilizing gold electrodes, die bonding with AuSn and wire bonding with gold wire are possible.
- 4. To improve handling of bonding, AuSn coating is available on one side or both sides.
- 5. Custom specifications (dimensions, cap. values, etc.) are also available upon request.

Applications

Microwave integrated circuits, microwave devices, optical devices, optical transceivers, TOSA/ROSA modules, measuring equipment, etc.



■ Single-electrode Type

Temperature Compensating 5C Characteristics (0±30ppm/°C)

Part Number		pc		6 9	<u> </u>	- Carac			(0_0		LB									
Size Code	OA	ос	OD	05	OE	OF	0G	ОН	01	09	1A	1B	1C	1E	1G	1H	2C	2E	2L	3G
L	0.25 0.25	0.35 0.25	1	1	1															
W T (max.)	0.25 0.35	0.25 0.35	0.38 0.35	0.50	0.55 0.38 0.35	0.64	0.70 0.50 0.35	0.71 0.38 0.35	0.76 0.76 0.35	0.90	1.00 0.64 0.35	1.09 0.76 0.35	1.27 1.27 0.35	0.90	1.73 1.27 0.35	1.78 1.78 0.45	2.19 1.27 0.45	2.29 0.45	2.95 1.78 0.45	2.29
Capacitance and						-			-											
0.1pF (0R1)	В																			
0.2pF (0R2)		В	В																	
0.3pF (0R3)			В	В		В														
0.4pF (0R4)			В	В		В			В											
0.5pF (0R5)				В	В	В			В	В										
0.6pF (0R6)				В	В	В			В	В										
0.7pF (0R7)						В	В	В	В	В										
0.8pF (0R8)						В	В	В	В	В										
0.9pF (0R9)						В	В		В	В										
1.0pF (1R0)						К	K		K	К			K							
1.1pF (1R1)									K	K	K		K							
1.2pF (1R2)									K	K	K		K							
1.3pF (1R3)									K	K	K		K							
1.5pF (1R5)										K	K	K	K							
1.6pF (1R6)										K	K	K	K							
1.8pF (1R8)										K		K	K			K				
2.0pF (2R0)												K	K	K		K				
2.2pF (2R2)													K	K		K				
2.4pF (2R4)													K	K		K				
2.7pF (2R7)													K	K		K				
3.0pF (3R0)													K			K		K		
3.3pF (3R3)													K			K		K		
3.6pF (3R6)													K			K		K		
3.9pF (3R9)															K	K		K		
4.3pF (4R3)															K	K		K		
4.7pF (4R7)															K	K		K		
5.1pF (5R1)																K	K	K		
5.6pF (5R6)																K		K		
6.2pF (6R2)	-															K		K		
6.8pF (6R8)	_															K		K		
7.5pF (7R5)																		K	K	
8.2pF (8R2)																		K	K	
9.1pF (9R1)																		K	K	
10pF (100)	-																	K	К	
11pF (110)																				K
12pF (120)	-																			K
13pF (130)	-																			K
15pF (150)	-																			K
16pF (160)																			Щ_	K

Custom capacitors (dimensions, capacitance, etc.) are available upon request. Please contact us for details.

The characters shown in parentheses () following capacitance are part numbering codes.

Dimensions are shown in mm.

Capacitance Tolerance B: ±0.1pF, K: ±10%

Temperature Compensating 6U Characteristics (-750±60ppm/°C)

Part Number	-		34.0	,			(CLB	P.1.13	<u>-, </u>						
Size Code	0A	ОВ	ос	0D	05	0E	OF	0G	ОН	01	09	1A	1B	1C	1E	1H	2E
L	0.25	0.30	0.35	0.38	0.50	0.55	0.64	0.70	0.71	0.76	0.90	1.00	1.09	1.27	1.49	1.78	2.29
W T (max.)	0.25 0.35	0.25 0.35	0.25 0.35	0.38 0.35	0.50 0.35	0.38 0.35	0.64 0.35	0.50 0.35	0.38 0.35	0.76 0.35	0.90 0.35	0.64 0.35	0.76 0.35	1.27 0.35	0.90 0.35	1.78 0.45	2.29 0.45
Capacitance and			0.55	0.00	0.55	0.00	0.00	0.00	0.00	0.55	0.00	0.55	0.55	0.00	0.00	0.15	0.15
0.3pF (0R3)	В																
0.4pF (0R4)	В																
0.5pF (0R5)	В																
0.6pF (0R6)	В																
0.7pF (0R7)	В																
0.8pF (0R8)		В															
0.9pF (0R9)			В	В													
1.0pF (1R0)				К	К												
1.1pF (1R1)				К	К												
1.2pF (1R2)				K	K												
1.3pF (1R3)				K	K												
1.5pF (1R5)				K	K												
1.6pF (1R6)				K	K												
1.8pF (1R8)					K	K											
2.0pF (2R0)					K	K	K										
2.2pF (2R2)					K	K	K										
2.4pF (2R4)					K	K	K										
2.7pF (2R7)							K	K	K								
3.0pF (3R0)							K	K		K							
3.3pF (3R3)							K			K	K						
3.6pF (3R6)							K			K	K						
3.9pF (3R9)							K			K	K						
4.3pF (4R3)							K			K	K						
4.7pF (4R7)										K	K	K					
5.1pF (5R1)										K	K	K					
5.6pF (5R6)										K	K	K					
6.2pF (6R2)										K	K	K					
6.8pF (6R8)											K		K				
7.5pF (7R5)													K	K	K		
8.2pF (8R2)														K	Κ		
9.1pF (9R1)														K	K		
10pF (100)														K			
11pF (110)														K			
12pF (120)														K			
13pF (130)														K		K	
15pF (150)														K		K	
20pF (200)																	K

 $Custom\ capacitors\ (dimensions, capacitance, etc.)\ are\ available\ upon\ request.\ Please\ contact\ us\ for\ details.$

Dimensions are shown in mm.

Capacitance Tolerance B: ±0.1pF, K: ±10%

The characters shown in parentheses () following capacitance are part numbering codes.

High Dielectric B5 Characteristics (±10%)

Part Number									CLB								
Size Code	0A	ОВ	oc	0D	05	0E	OF	0G	ОН	01	09	1A	1C	1E	1G	1H	2E
L W T (max.)	0.25 0.25 0.35	0.30 0.25 0.35	0.35 0.25 0.35	0.38 0.38 0.35	0.50 0.50 0.35	0.55 0.38 0.35	0.64 0.64 0.35	0.70 0.50 0.35	0.71 0.38 0.35	0.76 0.76 0.35	0.90 0.90 0.35	1.00 0.64 0.35	1.27 1.27 0.35	1.49 0.90 0.35	1.73 1.27 0.35	1.78 1.78 0.45	2.29 2.29 0.45
Capacitance and																	
5.6pF (5R6)	к																
6.2pF (6R2)	К																
6.8pF (6R8)	К																
7.5pF (7R5)	К																
8.2pF (8R2)	К																
9.1pF (9R1)	К																
10pF (100)	К																
11pF (110)	К																
12pF (120)	К																
13pF (130)		К															
15pF (150)		K															
16pF (160)			К														
18pF (180)			К	К													
20pF (200)				К													
22pF (220)				К	К												
24pF (240)				К	К												
27pF (270)				К	К												
30pF (300)				K	K												
33pF (330)					K	К											
36pF (360)					K	K											
39pF (390)					К	K											
43pF (430)					K	K	K										
47pF (470)					- 1	- 1	K	К	К								
51pF (510)							K	K	K								
56pF (560)							K	K	K								
62pF (620)							K	K	IX.								
68pF (680)							K	K		К	К						
75pF (750)							K	K		K	K						
82pF (820)							N.			K	K	к					
										K	K	K					
91pF (910) 100pF (101)										K	K	K					
110pF (111)										K	K	K					
											K	K					
120pF (121)											K	Γ.					
130pF (131)											Γ.			V			
150pF (151)													v	K			
160pF (161)													K	K			-
180pF (181)													K				-
200pF (201)													К		12	12	
300pF (301)															K	K	
330pF (331)																K	
360pF (361)																K	
390pF (391)																K	
430pF (431)																K	
470pF (471)																	K
510pF (511)																	K
560pF (561)																	K
620pF (621)																	K

Custom capacitors (dimensions, capacitance, etc.) are available upon request. Please contact us for details.

The characters shown in parentheses () following capacitance are part numbering codes.

Dimensions are shown in mm.

Capacitance Tolerance K: ±10%

High Dielectric F9 Characteristics (+30%, -80%)

Part Number						CI	B					
Size Code	0A	ОВ	ос	0D	05	0E	OF	0G	ОН	01	09	1A
L W T (max.)	0.25 0.25 0.35	0.30 0.25 0.35	0.35 0.25 0.35	0.38 0.38 0.35	0.50 0.50 0.35	0.55 0.38 0.35	0.64 0.64 0.35	0.70 0.50 0.35	0.71 0.38 0.35	0.76 0.76 0.35	0.90 0.90 0.35	1.00 0.64 0.35
Capacitance and	Tolerance											
27pF (270)	М											
30pF (300)	М											
33pF (330)	М											
36pF (360)		М										
39pF (390)		М										
43pF (430)			М									
47pF (470)			М									
51pF (510)			М									
62pF (620)				М								
68pF (680)				М								
75pF (750)				М	М							
82pF (820)				М	М							
91pF (910)					М	М						
100pF (101)					М	М						
110pF (111)					М	М						
120pF (121)					М	М						
130pF (131)					М		М		М			
150pF (151)							М	М	М			
160pF (161)							М	М				
180pF (181)							М	М				
200pF (201)							М	М		М	М	
220pF (221)							М			М	М	
240pF (241)										М	М	М
270pF (271)										М	М	М
300pF (301)										М	М	М
330pF (331)											М	М
360pF (361)											М	М
390pF (391)											М	

 $Custom\ capacitors\ (dimensions, capacitance, etc.)\ are\ available\ upon\ request.\ Please\ contact\ us\ for\ details.$

The characters shown in parentheses () following capacitance are part numbering codes.

Dimensions are shown in mm.

Capacitance Tolerance M: ±20%

High Dielectric W1 Characteristics (+30%, -90%)

Part Number		(100)		LB		
Size Code	0A	0D	05	OF	01	09
L W T (max.)	0.25 0.25 0.35	0.38 0.38 0.35	0.50 0.50 0.35	0.64 0.64 0.35	0.76 0.76 0.35	0.90 0.90 0.35
Capacitance and T	olerance					
36pF (360)	Z					
39pF (390)	Z					
43pF (430)	Z					
47pF (470)	Z					
51pF (510)	Z					
56pF (560)	Z					
91pF (910)		z				
100pF (101)		z				
110pF (111)		z				
120pF (121)		z				
130pF (131)		z	z			
150pF (151)		z	Z			
160pF (161)			Z			
180pF (181)			Z			
200pF (201)			Z			
220pF (221)			Z	Z		
240pF (241)				Z		
270pF (271)				Z		
300pF (301)				Z		
330pF (331)				z	Z	
360pF (361)				z	Z	
390pF (391)				z	z	z
430pF (431)					z	z
470pF (471)					z	z
510pF (511)					z	z
560pF (561)					Z	Z
620pF (621)						z
680pF (681)						Z

 $Custom\ capacitors\ (dimensions, capacitance, etc.)\ are\ available\ upon\ request.\ Please\ contact\ us\ for\ details.$

The characters shown in parentheses () following capacitance are part numbering codes.

Dimensions are shown in mm.

Capacitance Tolerance Z: +80%, -20%

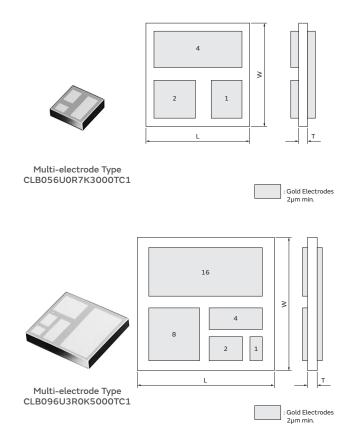
■ Multi-electrode Type

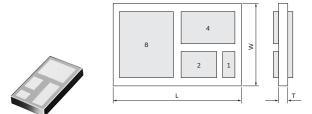
Part Number	Dimensions (mm)	Capacitance (pF)	Temperature Coefficient	Rated Voltage (Vdc)
CLB056U0R7K3000TC1	L 0.50 x W 0.50 x T(max.) 0.35	0.7	-750±60 ppm/°C	100
CLB0K6U1R5K4000TC1	L 0.90 x W 0.50 x T(max.) 0.35	1.5	-750±60 ppm/°C	100
CLB096U3R0K5000TC1	L 0.90 x W 0.90 x T(max.) 0.35	3.0	-750±60 ppm/°C	100

Custom capacitors (dimensions, capacitance, etc.) are available upon request. Please contact us for details.

Capacitance Tolerance K: ±10%

The above capacitance values are of the largest electrodes.





Multi-electrode Type CLB0K6U1R5K4000TC1



Thin Film Circuit Substrates (RUSUB)

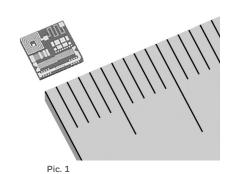
RU Series

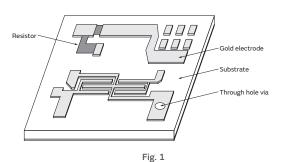
Features

- High Q value and high dielectric constant material enables low insertion loss and miniaturization of the device
- 2. A wide selection of substrate materials meets customer's requirements.
- 3. Metallization process suitable for each substrate material achieves excellent reliability.
- 4. By utilizing gold electrodes, die bonding with AuSn and wire bonding with gold wire are possible.
- 5. Thin film microfabrication technology allows precise micro pattern.
- 6. Through hole via and AuSn pre-coating are available.
- CR composite products are also available by combining high dielectric capacitor and thin film resistor.



Devices for microwave, milimeter wave and optical communication, MIC circuit substrates, impedance matching circuit substrates, bypass circuit substrates, couplers, filters, capacitors, capacitor networks, resistor networks, etc.





Substrate Characteristics and General Specifications

Table 1. Substrate Characteristics and General Specifications

Substrate Material Code	Dielectric Constant (ɛr) *1	Size min. (L×W×T) (mm) *2	Capacity Temperature Characteristics (ppm/°C) *3	Through Hole	TaN Resistance	L/S min. (µm) *4	Coefficient of Thermal Expansion (ppm/°C) *1	Temperature Conductivity (W/(m·°C)) *1
N	9	0.25×0.25×0.09	_	0	0		4.6	200.0
Α	10	0.25×0.25×0.20	-	0	0		7.0	33.5
Н	39	0.25×0.25×0.09	0±30	×	0	20/20/4	6.6	1.9
K	90	0.25×0.25×0.09	-330±120	×	0	30/30 (Au thickness	9.2	2.3
U	150	0.25×0.25×0.09	-750±120	×	0	4µm)	11.7	2.0
F	250	0.25×0.25×0.09	-750±600	×	0	50/50 (Au	12.2	4.0
Υ	3000	0.25×0.25×0.09	±10%	×	0	thickness	10.7	2.5
Z	10000	0.25×0.25×0.09	+30, -80%	×	×	- 8μm)	10.5	1.6
Х	15000	0.25×0.25×0.09	+30, -90%	×	×		14.0	2.4
Q	30000	0.25×0.25×0.25	±25%	×	0		11.2	7.35

^{*1} Typical value

11

^{*2} L = length, W = width, T = thickness

^{*3} Temperature Range: -25 to 85°C, Reference Temperature: 25°C

^{*4} L = line, S = space

Resistor Specifications

Table 2. Resistor Specifications

Material	TaN
Sheet Resistance (Ω)	12.5, 25, 50
Operating Temperature Range (°C)	-55 to 125
Rated Voltage (mW/mm²)	100
Resistance Tolerance (%) *	±20
Resistance Temperature Coefficient (ppm/°C)	-70±50

^{*} Please contact us for smaller resistor tolerance.

Through Hole Via Specifications

Table 3. Through Hole Via Specifications

a: Hole to Hole (mm)	0.22 min.
b: Distance between Hole and Electrode (mm)	0.10 min.
c: Distance between Electrode and Chip Edge (mm)	0.15 min.

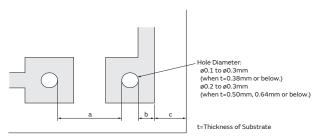


Fig. 2 Through Hole Via Diameter

AuSn Pre-coating Type

Table 4. AuSn Pre-coating Specifications

1. AuSn Pre-coating Thickness	5±2μm, 10±3μm, 15±4μm
2. Coating Size	Min 150µm□±10µm (5µm Thickness) Min 150µm□±20µm (10, 15µm Thickness)
3. AuSn Electrode Offset (Top Side)	≥25µm
4. AuSn Electrode Offset (Bottom Side)	≧50µm

Au Electrode

Table 5. Au Electrode Specifications

Thickness	4µm	8µm
Dimension Tolerance	±10µm	±15µm
Offset	50µm (from ch	nip edge)

 $^{^{\}star}$ 15 μm thickness is also available upon request.

Note

Data sending method: When requiring our product, please send pattern by CAD data and information to our local sales.

Table 6. Information of Sending Data

3	
CAD Data Format	DXF, DWG
	<u> </u>

Examples of RUSUB Offering

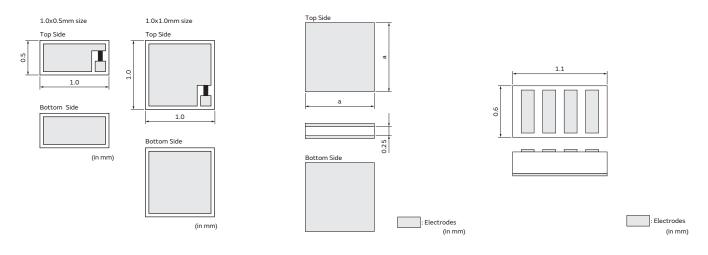
- Thirteen types of standard products of RUSUB C+R (Capacitor + Resistor) are available.
- The custom substrate dimensions, capacitance, resistance value, and electrode pattern shape are also available upon request.

Part Number	Dimensions	Thickness	Capacitance	Resistance
RUCYT101K00009GNTC	1.0mm×0.5mm	0.11 ±0.025mm	100pF ±10%	50Ω ±20%
RUCYT101K00011GNTC	1.0mm×0.5mm	0.11 ±0.025mm	100pF ±10%	100Ω ±20%
RUCYT101K00012GNTC	1.0mm×0.5mm	0.11 ±0.025mm	100pF ±10%	200Ω ±20%
RUCYT201K00010GNTC	1.0mm×1.0mm	0.12 ±0.025mm	200pF ±10%	50Ω ±20%
RUCYT201K00013GNTC	1.0mm×1.0mm	0.12 ±0.025mm	200pF ±10%	100Ω ±20%
RUCYT201K00014GNTC	1.0mm×1.0mm	0.12 ±0.025mm	200pF ±10%	200Ω ±20%

Part Number	Dimensions (a)	Thickness	Capacitance
RUCQD101RCC007GNTC	0.34 ±0.10mm	0.25 ±0.01mm	100pF +60%/-20%
RUCQD431RCC001GNZB	0.70 ±0.20mm	0.25 ±0.01mm	430pF +60%/-20%
RUCQD471RCC002GNZB	0.73 ±0.20mm	0.25 ±0.01mm	470pF +60%/-20%
RUCQD511RCC003GNZB	0.76 ±0.25mm	0.25 ±0.01mm	510pF +60%/-20%
RUCQD561RCC004GNZB	0.80 ±0.25mm	0.25 ±0.01mm	560pF +60%/-20%
RUCQD102RCC008GNZB	1.07 ±0.30mm	0.25 ±0.01mm	1000pF +60%/-20%

Part Number	Dimensions	Thickness	Capacitance
RUCQD201ZCC005GNZB	1.1mm×0.6mm	0.25 ±0.01mm	200pF×4

Shape



RUCYT Series RUCQD Series

Specifications and Test Methods

No.	No. Item		Specifications	Test Methods
1	Operating Temperature Range		-55 to 125°C	
2	2 Appearance		No lifting No scratch that exposes the ceramic material	Microscope at 20x magnification
3	3 Rated Voltage		100Vdc (except Q) 65Vdc (Q)	
4	Capacitance		Within the specified tolerance	MIL-STD-202 Method 305 Measurement Frequency: Temp. Comp.: 1MHz±10% High Dielectric: 1kHz±10% Measurement Voltage: 1Vrms
5	Q/Dissipation Factor (D. F.)		H, 5C: Q≧200 K, U, F, 6U: Q≧100 Y, Z, B5, F9: D. F.≦2.5% X, Q, W1: D. F.≦4%	MIL-STD-202 Method 306 Test frequency and voltage are the same as those of the capacitance test.
6	insulation Resistance (I. R.)		25°C: 100000MΩ min. (except Q) 100MΩ min. (Q) 125°C: 10000MΩ min. (except Q) 10MΩ min. (Q)	MIL-STD-202 Method 302 Measurement Voltage: Rated Voltage Measurement Temperature: 25±2°C and 125±2°C Measurement Time: Within 2 minutes
7	Dielectric Withstanding Voltage (D. W. V.)		Satisfies the following performance	MIL-STD-202 Method 301 Measurement Voltage: 250 Vdc Applied Time: 1 to 5 seconds Charge/Discharge Current: 50mA max.
8	8 Temperature Characteristics (Temperature Coefficient)		H, 5C: 0±30ppm/°C 6U: -750±60ppm/°C K: -330±120ppm/°C U: -750±120ppm/°C F: -750±600ppm/°C Y, B5: ±10% Z, F9: +30, -80% W, W1: +30, -90% Q: ±25%	The capacitance change should be measured at each specified temperature stage.
9	Mechanical Strength	Bond Strength	Pull force: 3.0g min. No electrode lifting	MIL-STD-883 Method 2011Condition D Mount the capacitors on a gold metallized alumina substrate with AuSn (80/20) and bond a 25µm gold wire to the capacitor electrode using ball bonding. Then, pull the wire.
		Die Shear Strength	Complies with MIL-STD-883 Method 2019	MIL-STD-883 Method 2019 Mount the capacitors on a gold metallized alumina substrate with AuSn (80/20). Apply force in the horizontal direction.
		Appearance	Satisfies the specification "Appearance"	MIL-STD-202 Method 201
10	Vibration	Capacitance	Within the specified tolerance	Type of Vibration: 10 to 55 to 10Hz (1 min) Total Amplitude: 1.5mm
		Q/D. F.	Initial Value	This motion should be applied for a period of 2h in each of 3 mutually perpendicular directions (total of 6h).
		Appearance	Satisfies the specification "Appearance"	
	Thermal Shock	Capacitance Change	F, 5C, 6U: ≦±5% or ≦±0.5pF (whichever is greater) Q, B5, F9, W1: ≦±10%	MIL-STD-202 Method 107Condition A-1
11		Q/D. F.	Initial Value	Note: Temperature in Step 3: 125±3 °C
11		I. R.	1000MΩ min. (except Q) 10MΩ min. (Q)	Test time in Step 1 and 3: 30 min Exposure Time: H, K, U, F, Q, 5C, 6U: 24±2h
		D. W. V.	Satisfies the specification "D. W. V"	B5, F9, W1, Y, Z, X: 48±4h
		Appearance	Satisfies the specification "Appearance"	
	Humidity (No Load)	Capacitance Change	H, K, U, F, 5C, 6U: ≦±5% or ≦±0.5pF (whichever is greater) Q, B5, F9, W1: ≦±10%	MIL-STD-202 Method 103
12		Q/D. F.	H, K, U, F, 5C, 6U: Q≥100 Y, Z, B5, F9: D. F.≤2.5% Q, W1: D. F.≤4%	Temperature: 60±5°C Humidity: 90 to 95%RH Test Time: 1000±12h Exposure Time: H, K, U, F, Q, 5C, 6U: 24±2h
		I. R.	≥30% of initial value (except Q) ≥10% of initial value (Q)	B5, F9, W1, Y, Z, X: 48±4h
		D. W. V.	Satisfies the specification "D. W. V"	

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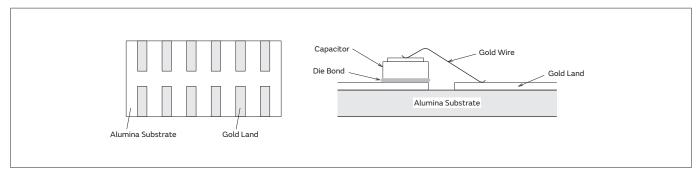


Specifications and Test Methods

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No.	Item	Specifications	Test Methods
	Appearance	Satisfies the specification "Appearance"	
	Capacitance Change	H, K, U, F, 5C, 6U: ≦±5% or ≦±0.5pF (whichever is greater) Q, B5, F9, W1: ≦±10%	MIL-STD-202 Method 108 Test Temperature: 125±3°C
High 13 Tempe Load	Q/D. F.	H, K, U, F, 5C, 6U: Q≥100 Y, Z, B5, F9: D. F.≦2.5% Q, W1: D. F.≦4%	Applied Voltage: 200% x Rated Voltage Test Time: 1000±12h Exposure Time: H, K, U, F, Q, 5C, 6U: 24±2h B5, F9, W1, Y, Z, X: 48±4h
	I. R.	≥30% of initial value (except Q) ≥10% of initial value (Q)	
	D. W. V.	Satisfies the specification "D. W. V"	
	Appearance	Satisfies the specification "Appearance"	
	Capacitance Change	H, K, U, F, 5C, 6U: ≦±5% or ≦±0.5pF (whichever is greater) Q, B5, F9, W1: ≦±10%	Temperature: 85±2°C Humidity: 85±5%RH
14 Humio Load	Q/D. F.	H, K, U, F, 5C, 6U: Q≥100 Y, Z, B5, F9: D. F.≤2.5% Q, W1: D. F.≤4%	Bias Voltage: 1.5V±10% Test Time: 240h Exposure Time: H, K, U, F, Q, 5C, 6U: 24±2h B5. F9. W1. Y. Z. X: 48±4h
	I. R.	10000MΩ min. (except Q) 10MΩ min. (Q)	25, . 5, 2, 1, 2, 7 152
	D. W. V.	Satisfies the specification "D. W. V"	

Mounting for testing: The capacitors should be mounted on the substrate as shown below using die bonding and wire bonding when tests No. 10 to 14 are performed.



Notice

Notice

Please note the following conditions to retain the solderability of the products.

- 1. Store the products in the manufacturer's or a sealed box with the following conditions.
 - Temperature: -10 to 40°C without rapid change
 - Humidity: 30 to 70%RH
- 2. Avoid storing the products in the following conditions.
 - (a) Ambient air containing corrosive gas (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas, nitric oxide gas, etc.)

- (b) Ambient air containing volatile or combustible gas
- (c) In environments with a high concentration of airborne particles
- (d) In liquid (water, oil, chemical solution, organic solvents, etc.)
- (e) In environments prone to dew
- (f) In direct sunlight
- (g) In freezing environments
- 3. To retain solderability, do no touch the products directly with bare hands.

Notice (Soldering and Mounting)

- 1. Die Bonding
 - (1) Materials and bonding conditions
 - Solders: Au-20%Sn
 - Bonding temperature: 300 to 320°C
 - Bonding time: Within 1 minute
 - Bonding atmosphere: N2 atmosphere
 - (2) Notice
 - (a) Please mount the products with gentle scrubbing.
 - (b) Die bonding condition is affected by what type of solder and base substrate are used.

Please evaluate die bonding condition in advance with the same materials as mass production materials and ensure that there is no effect, especially cracking of the ceramic.

- 2. Wire Bonding
 - (1) Materials and bonding conditions
 - Wire lead: 25 micron diameter gold wire
 - Bonding temperature: 150 to 250°C
 - Bonding methods: Thermocompression or thermosonic bonding
 - (2) Notice
 - (a) Please keep bonding more than 25 microns away from the edge of the electrode.

Please contact us for other bonding conditions not listed above.

Global Locations

For details please visit www.murata.com



Note

1 Export Control

For customers outside Japan:

No Murata products should be used or sold, through any channels, for use in the design, development, production, utilization, maintenance or operation of, or otherwise contribution to (1) any weapons (Weapons of Mass Destruction [nuclear, chemical or biological weapons or missiles] or conventional weapons) or (2) goods or systems specially designed or intended for military end-use or utilization by military end-users.

For customers in Japan:

For products which are controlled items subject to the "Foreign Exchange and Foreign Trade Law" of Japan, the export license specified by the law is required for export.

- 2 Please contact our sales representatives or product engineers before using the products in this catalog for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this catalog.
 - Aircraft equipment
 - Aerospace equipment
 - 3 Undersea equipment
 - Power plant equipment
 - Medical equipment
 - (6) Transportation equipment (vehicles, trains, ships, etc.)
 - Traffic signal equipment
 - S Disaster prevention / crime prevention equipment
 - Data-processing equipment
 - Application of similar complexity and/or reliability requirements to the applications listed above

- 3 Product specifications in this catalog are as of April 2019. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.
- 4 Please read rating and \(\Delta\)CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
- This catalog has only typical specifications.
 Therefore, please approve our product
 specifications or transact the approval sheet
 for product specifications before ordering.
- Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or a third party's intellectual property rights and other related rights in consideration of your use of our products and/or information described or contained in our catalogs. In this connection, no representation shall be made to the effect that any third parties are authorized to use the rights mentioned above under licenses without our consent.
- 7 No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.

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